

#### **Features**

- Average Rectified Output Current: I<sub>O</sub>=150 mA
- Power Dissipation of 225mw

## **Package Marking and Ordering Information**

| Product ID | Pack   | Marking | Qty(PCS) |
|------------|--------|---------|----------|
| BAS16      | SOT-23 | A6      | 3000     |



### Maxmim Ratings (Ta=25°C unless otherwise noted)

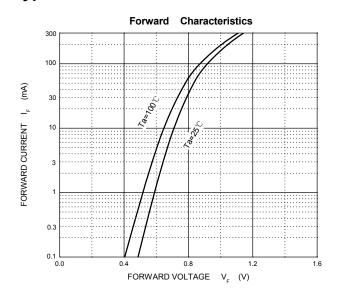
| Parameter  | Symbol              | Limit    | Unit |
|--|---------------------|----------|------|
| Non-Repetitive Peak Reverse Voltage                | $V_{RM}$            | 100      | V    |
| Peak Repetitive Peak Reverse Voltage Working Peak  | $V_{RRM}$           |          |      |
| Reverse Voltage                                    | $V_{RWM}$           | 75       | V    |
| DC Blocking Voltage                                | $V_R$               |          |      |
| RMS Reverse Voltage                                | V <sub>R(RMS)</sub> | 53       | V    |
| Forward Continuous Current                         | I <sub>FM</sub>     | 300      | mA   |
| Average Rectified Output Current                   | Io                  | 150      | mA   |
| Non-Repetitive Peak Forward Surge Current @t=8.3ms | I <sub>FSM</sub>    | 2.0      | А    |
| Power Dissipation                                  | Pd                  | 225      | mW   |
| Thermal Resistance Junction to Ambient             | $R_{	heta JA}$      | 556      | °C/W |
| Junction Temperature                               | Tj                  | 150      | °C   |
| Storage Temperature                                | T <sub>STG</sub>    | -55~+150 | ℃    |

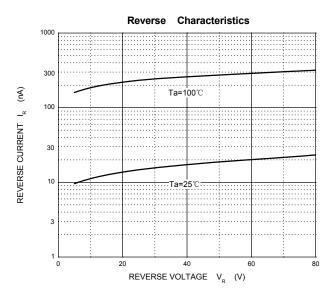
# Electrcal Charcteristics (Ta=25°C unless otherwise specified)

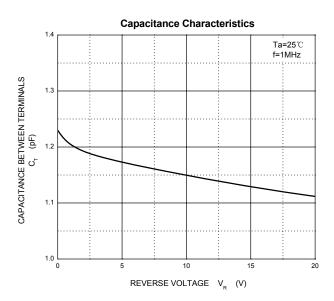
|                                 | •               |  | •   | _                           | _    |
|---------------------------------|-----------------|--|-----|-----------------------------|------|
| Parameter                       | Symbol          | Test conditions  | Min | Max                         | Unit |
| Reverse breakdown voltage       | $V_{(BR)}$      | I <sub>R</sub> = 100μA   | 75  |                             | V    |
| Reverse voltage leakage current | I <sub>R</sub>  | V <sub>R</sub> =75V  |     | 1                           | μA   |
| Forward voltage                 | V <sub>F</sub>  | I <sub>F</sub> =1mA<br>I <sub>F</sub> =10mA<br>I <sub>F</sub> =50mA<br>I <sub>F</sub> =150mA |     | 0.715<br>0.855<br>1<br>1.25 | V    |
| Diode capacitance               | $C_D$           | V <sub>R</sub> =0, f=1MHz  |     | 2                           | pF   |
| Reveres recovery time           | t <sub>rr</sub> | $I_F=I_R=10$ mA, $I_{rr}=0.1\times I_R$ ,<br>$R_L=100\Omega$                                 |     | 6                           | ns   |

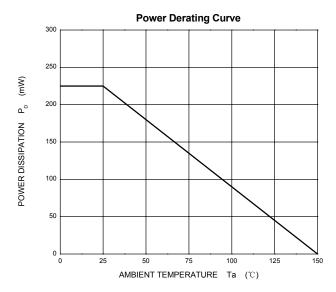


# **Typical Characteristics**



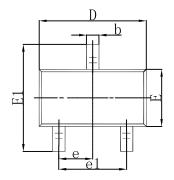


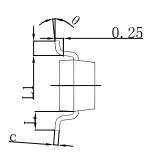


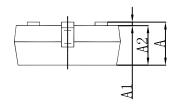




# **SOT-23 Package Outline Dimensions**

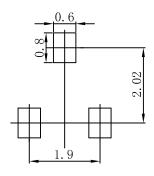






| Cumbal | Dimensions In Millimeters |                  | Dimensions In Inches |       |  |
|--------|---------------------------|------------------|----------------------|-------|--|
| Symbol | Min                       | Max              | Min                  | Max   |  |
| Α      | 0.900                     | 1.150            | 0.035                | 0.045 |  |
| A1     | 0.000                     | 0.100            | 0.000                | 0.004 |  |
| A2     | 0.900                     | 1.050            | 0.035                | 0.041 |  |
| b      | 0.300                     | 0.500            | 0.012                | 0.020 |  |
| С      | 0.080                     | 0.150            | 0.003                | 0.006 |  |
| D      | 2.800                     | 3.000            | 0.110                | 0.118 |  |
| E      | 1.200                     | 1.400            | 0.047                | 0.055 |  |
| E1     | 2.250                     | 2.550            | 0.089                | 0.100 |  |
| е      | 0.950                     | TYP              | 0.037 TYP            |       |  |
| e1     | 1.800                     | 2.000            | 0.071                | 0.079 |  |
| L      | 0.550                     | 550 REF 0.022 RE |                      | REF   |  |
| L1     | 0.300                     | 0.500            | 0.012                | 0.020 |  |
| θ      | 0°                        | 8°               | 0°                   | 8°    |  |

## **SOT-23 Suggested Pad Layout**



- Note: 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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